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TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74HC245AP,TC74HC245AF,TC74HC245AFW TC74HC640AP,TC74HC640AF

Octal Bus Transceiver

TC74HC245AP/AF/AFW 3-State,

Non-Inverting

TC74HC640AP/AF 3-State, Inverting

The TC74HC245A, 640A are high speed CMOS OCTAL BUS TRANSCEIVERs fabricated with silicon gate C2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

They are intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

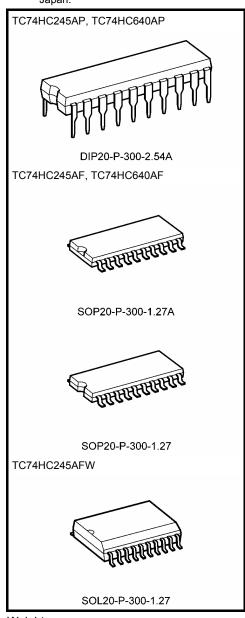
The enable input ( $\overline{G}$ ) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### Features (Note 1)(Note 2)

- High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 6 mA (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2~6 V
- Pin and function compatible with 74LS245/640
  - Note 1: Do not apply a signal to any bus terminal when it is in the output mode. Damage may result.
  - Note 2: All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.

Note: xxxFW (JEDEC SOP) is not available in Japan.



Weight

 DIP20-P-300-2.54A
 : 1.30 g (typ.)

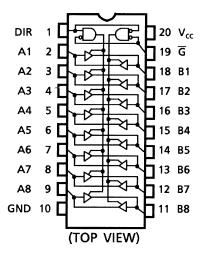
 SOP20-P-300-1.27A
 : 0.22 g (typ.)

 SOP20-P-300-1.27
 : 0.22 g (typ.)

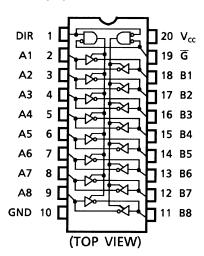
 SOL20-P-300-1.27
 : 0.46 g (typ.)

#### **Pin Assignment**

#### **TC74HC245A**

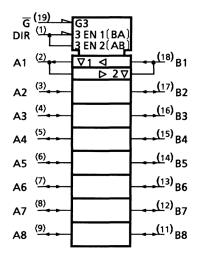


#### **TC74HC640A**

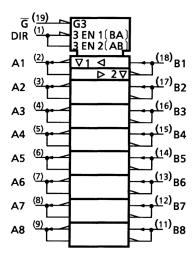


## **IEC Logic Symbol**

#### **TC74HC245A**



#### **TC74HC640A**



#### **Truth Table**

Inputs		Fun	ction	Outputs			
G	DIR	A Bus	B Bus	B Bus HC245A			
L	L	Output	Output Input		$A = \overline{B}$		
L	Н	Input	Output	B = A	$B = \overline{A}$		
Н	Х	2	7_	Z	Z		

X: "H" or "L"

Z: High impedance

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## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5~7	V
DC input voltage	V <sub>IN</sub>	-0.5~V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5~V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	<b>−65~150</b>	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: 500 mW in the range of Ta = -40 to  $65^{\circ}C$ . From Ta = 65 to  $85^{\circ}C$  a derating factor of -10 mW/°C shall be applied until 300 mW.

## **Operating Range (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2~6	V
Input voltage	V <sub>IN</sub>	0~V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	<b>V</b>
Operating temperature	T <sub>opr</sub>	-40~85	°C
		0~1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0~500 (V <sub>CC</sub> = 4.5 V)	ns
		0~400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating range is required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either VCC or GND. Please connect both bus inputs and the bus outputs with VCC or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.



## **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition $V_{CC}\left(V\right)$		Ta = 25°C			Ta = -40~85°C		Unit	
Characteristics	Symbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic
High-level input voltage		_		2.0	1.50	_	_	1.50	_	
	$V_{IH}$			4.5	3.15	_	_	3.15	_	V
, and the second				6.0	4.20	—	_	4.20	_	
				2.0	_		0.50		0.50	
Low-level input voltage	V <sub>IL</sub>	_		4.5	_	_	1.35	_	1.35	V
				6.0	_	_	1.80	_	1.80	
	V <sub>ОН</sub>			2.0	1.9	2.0	_	1.9	_	
		VIN = VIH or VIL	$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	V <sub>OL</sub>	VIN = VIH or VIL		2.0		0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0		0.0	0.1	_	0.1	٧
			I <sub>OL</sub> = 6 mA	4.5		0.17	0.26	_	0.33	
			$I_{OL} = 7.8 \text{ mA}$	6.0		0.18	0.26	_	0.33	
3-state output	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND		6.0			±0.5		± <b>5</b> 0	
off-state current				6.0	_	_	±0.5		±5.0	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	4.0	_	40.0	μΑ



AC Characteristics (input:  $t_r = t_f = 6$  ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit	
Characteristics	Symbol		CL (pF)	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic
Output transition time	t <sub>TLH</sub>	_	50	2.0 4.5	_	52 7	60 12		75 15	ns
	t <sub>THL</sub>			6.0	_	6	10	_	13	110
		_	50	2.0	_	33	90	_	115	- ns
				4.5	_	12	18	_	23	
Propagation delay	$t_{pLH}$			6.0	_	10	15	_	20	
time	$t_{pHL}$			2.0	_	48	120	_	150	
			150	4.5	_	16	24	_	30	
				6.0	_	14	20	_	26	
	<sup>t</sup> pZL <sup>t</sup> pZH	$R_L = 1k\Omega$	50	2.0	_	48	150	_	190	- ns
				4.5	_	16	30	_	38	
3-state output enable				6.0	_	14	26	_	32	
time			150	2.0	_	63	180	_	225	
				4.5	_	21	36	_	45	
				6.0	_	18	31	_	38	
	t <sub>pLZ</sub> t <sub>pHZ</sub>	$R_L = 1k\Omega$	50	2.0	_	37	150	_	190	
3-state output disable time				4.5	_	17	30	_	38	ns
				6.0	_	15	26	_	32	
Input capacitance	C <sub>IN</sub>	DIR, G			_	5	10	_	10	pF
Bus input capacitance	C <sub>OUT</sub>	An, Bn			_	13	_	_	_	pF
Power dissipation	C <sub>PD</sub>	TC74HC245A			_	39	_	_	_	pF
capacitance	(Note)	TC74HC640A			_	37	_	_	_	рг

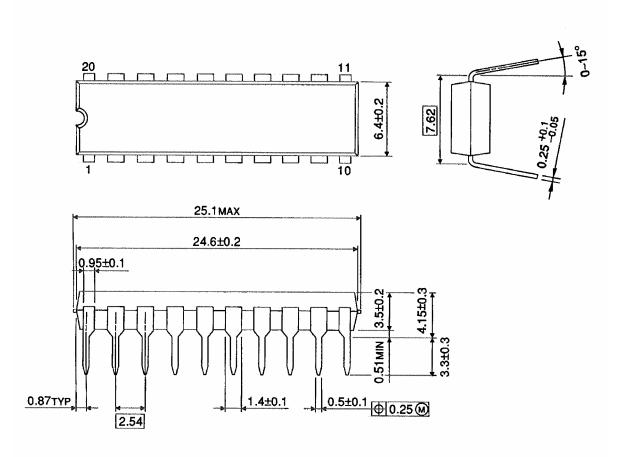
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$  (per bit)

## **Package Dimensions**

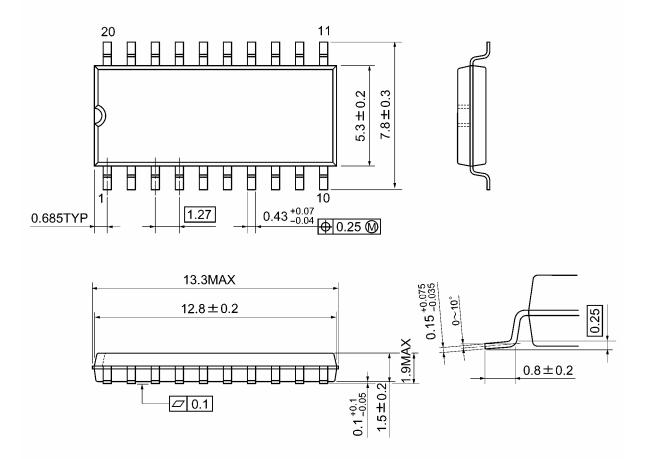


6

Weight: 1.30 g (typ.)

## **Package Dimensions**

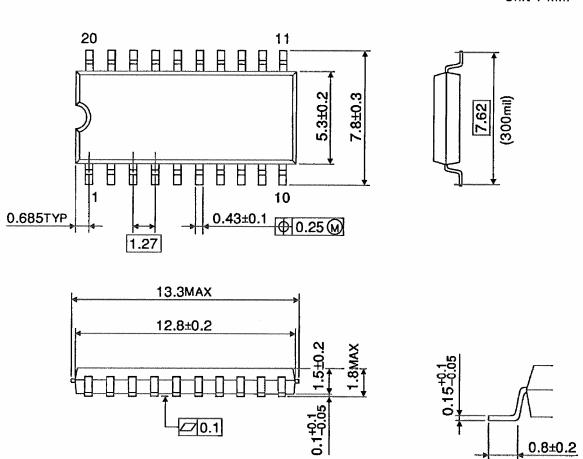
SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

## **Package Dimensions**

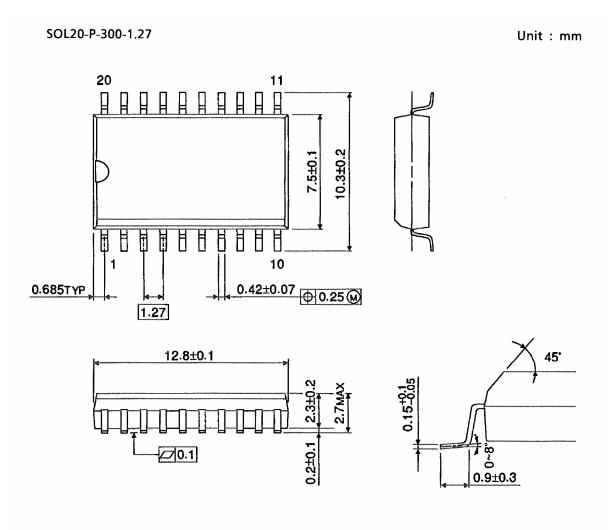
SOP20-P-300-1.27 Unit: mm



Weight: 0.22 g (typ.)



## **Package Dimensions (Note)**



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Note: This package is not available in Japan.

Weight: 0.46 g (typ.)

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20070701-EN

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